

N-Channel PowerTrench[®] MOSFET 30 V, 75 A, 1.3 m Ω

Features

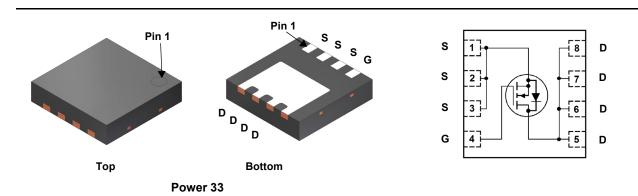
- Max $r_{DS(on)}$ = 1.3 m Ω at V_{GS} = 10 V, I_D = 30 A
- Max $r_{DS(on)}$ = 1.8 m Ω at V_{GS} = 4.5 V, I_D = 25 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for applications where ultra low $r_{DS(on)}$ is required in small spaces such as High performance VRM, POL and Oring functions.

Applications

- DC DC Buck Converters
- Point of Load
- High Efficiency Load Switch and Low Side Switching
- Oring FET



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter	Ratings	Units			
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Volage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		75		
	-Continuous (Silicon limited) T _C = 25 °C			166		
D	-Continuous	T _A = 25 °C	(Note 1a)	30	Α	
	-Pulsed			120		
E _{AS}	Single Pulse Avalance Energy		(Note 3)	153	mJ	
D	Power Dissipation	T _C = 25 °C		54	W	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.4		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	53	0/10

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8010	FDMC8010	Power 33	13 "	12 mm	3000 units

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April 2014

FDMC8010
N-Channel
PowerTrench
[®] MOSFET

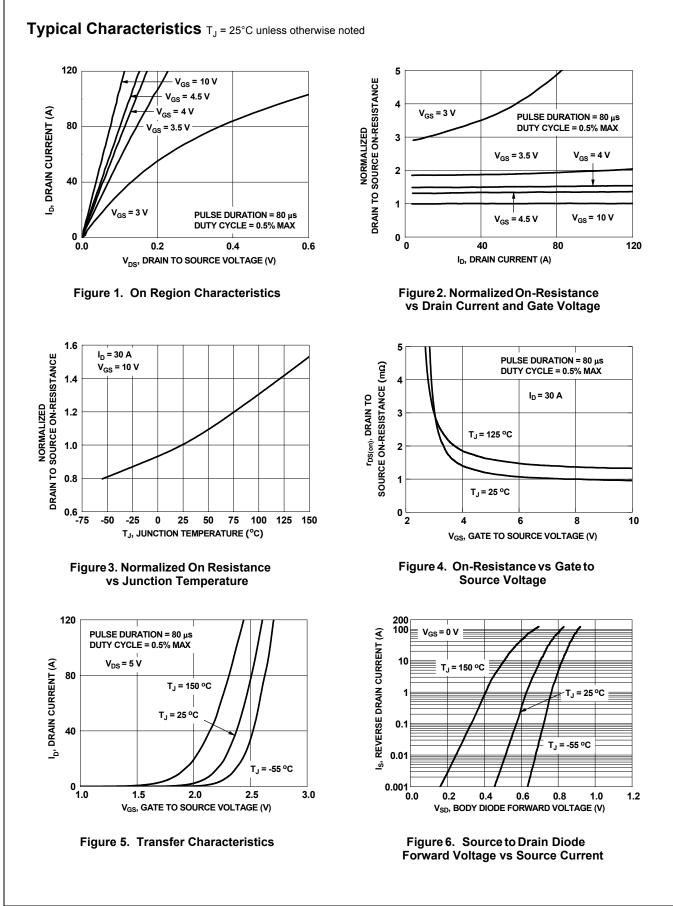
Off Chara	Parameter	Test Conditions	Min	Тур	Max	Units
	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, referenced to 25 °C		15		mV/°C
DSS	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.5	2.5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_D = 1$ mA, referenced to 25 °C		-5		mV/°C
ΔT_{J}	Temperature Coefficient				1.0	
	Statia Drain to Source On Desistance	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.9	1.3	
^r DS(on)	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 25 \text{ A}$		1.3	1.8	mΩ
~		$V_{GS} = 10 \text{ V}, I_D = 30\text{ A}, T_J = 125 \text{ °C}$		1.3	2	0
9FS	Forward Transconductance	V _{DS} = 5 V, I _D = 30 A		188		S
-	Characteristics					
C _{iss}	Input Capacitance			4405	5860	pF
C _{oss}	Output Capacitance	$v_{DS} = 15 \text{ V}, v_{GS} = 0 \text{ V},$ = f = 1 MHz		1570	2090	pF
C _{rss}	Reverse Transfer Capacitance			167	250	pF
R _g	Gate Resistance			0.5		Ω
Switching	g Characteristics					
d(on)	Turn-On Delay Time			15	27	ns
r	Rise Time	V _{DD} = 15 V, I _D = 30 A,		7.5	15	ns
d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		40	64	ns
f	Fall Time			5.3	11	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		67	94	nC
<u>g</u> ຊຸ	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		32	45	nC
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 30 \text{ A}$		10		nC
αgs Q _{gd}	Gate to Drain "Miller" Charge			9.5		nC
-	-			0.0		
Drain-Soເ	urce Diode Characteristics			1		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	1.2	v
- 30	-	$V_{GS} = 0 V, I_S = 30 A$ (Note 2)		0.7	1.2	
t _{rr}	Reverse Recovery Time	I _F = 30 A, di/dt = 100 A/μs		49	78	ns
Q _{rr}	Reverse Recovery Charge			29	46	nC

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

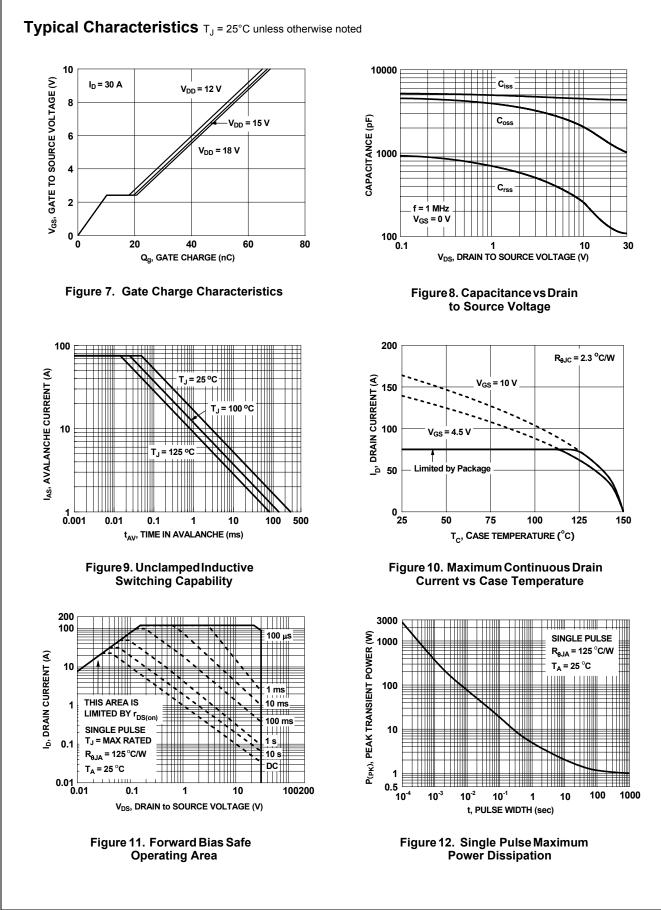
3. E_{AS} of 153 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 32 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 47 A.

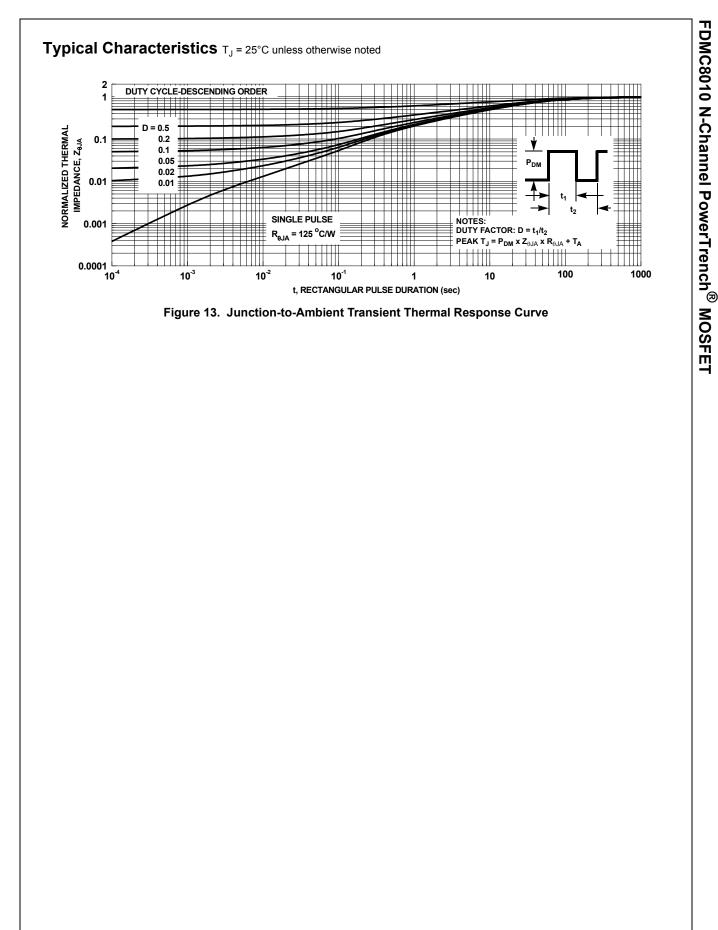
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

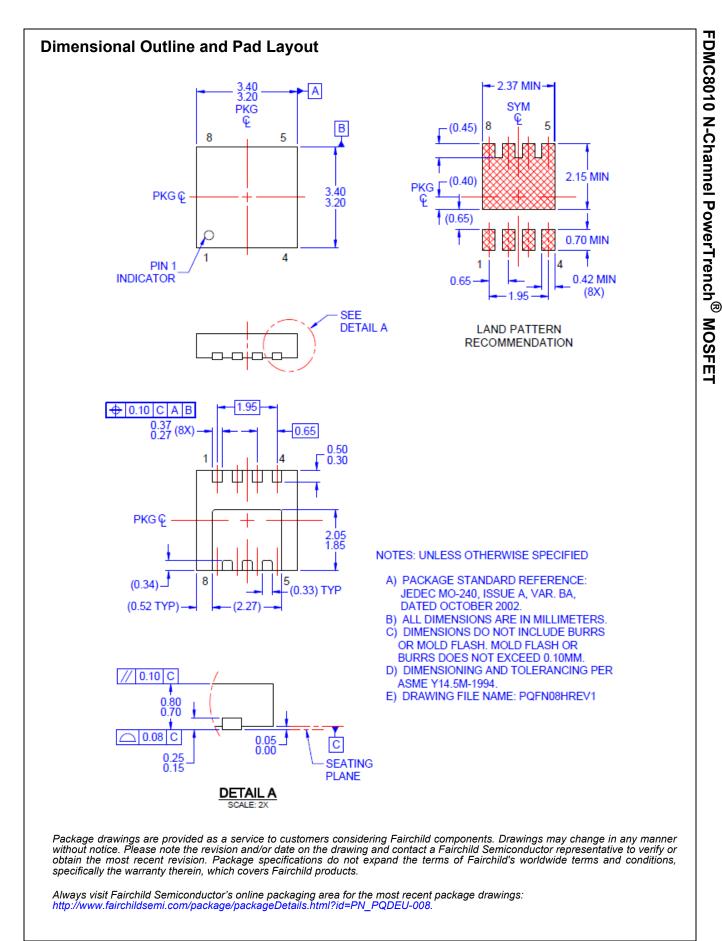
FDMC8010 N-Channel PowerTrench[®] MOSFET















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